

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:	)	
	:	Examiner: W. Leader
SHIGERU ICHIHARA ET AL.	)	
	:	Group Art Unit: 1795
Application No.: 10/566,949	)	
	:	Confirmation No. 3062
Int'l Application No. PCT/JP2005/000732	)	
	:	
Filed: January 14, 2005	)	
	:	
For: PLATING SOLUTION, PROCESS )		
FOR PRODUCING A STRUCTURE:		
WITH THE PLATING SOLUTION,)		
AND APPARATUS EMPLOYING :		
THE PLATING SOLUTION )		September 22, 2008

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

AMENDMENT

Sir:

A. Introductory Comments

In response to the Office Action dated June 26, 2008, please amend the above-captioned application as follows and consider the following remarks.